COMPANY OVERVIEW

DSP Group, Inc. (NASDAQ: DSPG) is a leading global provider of wireless chipset solutions for converged communications at home and office. Delivering semiconductor system solutions with software and reference designs, DSP Group enables OEMs/ODMs, consumer electronics (CE) manufacturers and service providers to cost-effectively develop new revenue-generating products with fast time to market. At the forefront of semiconductor innovation and operational excellence for over two decades, DSP Group provides a broad portfolio of wireless chipsets integrating DECT/CAT-iq, DECT ULE, Wi-Fi, PSTN, BoneTone™ intelligent voice enhancement and noise elimination, video and VoIP technologies. DSP Group enables converged voice, audio, video and data connectivity across diverse consumer and business products – from connected multimedia screens, mobile devices, and home automation & security to cordless phones, VoIP systems, and home gateways. Leveraging industry-leading experience and expertise, DSP Group partners with CE manufacturers and service providers to shape the future of converged communications at home and office. For more information, visit www.dspg.com.

FACTS AT-A-GLANCE

- Incorporated in 1987
- Initial public offering: 1994
- 2011 Revenues: $194 Million USD
- Number of employees worldwide: 395
- Headquarters: USA, San Jose
- Integrated circuits used in products by leading global brands including: AEG, Alcatel, AT&T, Belgacom, Binatone, British Telecom, Brother, CCT Tech, China Mobile, China Telecom, Deutsche Telekom, France Telecom, Freebox, GE, Giant Electronics, Global China Technologies, Grandstream, Huawei, JXE, Korea Telecom, KPN, LG Electronics, Motorola, NEC, NTT, OpenPeak, Panasonic, Philips, Pioneer, Plantronics, Sagem, Samsung, Sanyo, SGW, Sharp, Siemens (Gigaset), SK Telesys, Sony, Swisscom, TCL, Telecom Italia, Telefonica, Telstra, Thomson, Uniden, Urmet, Verizon, VTech, WNC, Xingtel, Yamaha and more.
- Over 1 billion chips used in the wireless communication at home market, with hundreds of millions of additional chips deployed each year
- Offices worldwide: San Jose, California (Headquarters), Rancho Cordova, Nürnberg, Edinburgh, Bangalore, Hong Kong, Tokyo and Herzeliya
- 185 US and Foreign Patents granted; 129 patents pending

MARKET INNOVATIONS

- 1989 ..... First Digital Telephony Answering Device (TAD) speech processor
- 1999 ..... 900MHz narrow-band cordless chipset for mass market
- 2002 ..... Complete chipset for a 2.4GHz multi handset solution
- 2006 ..... Integrated DECT, Wi-Fi and Application Processor on one chipset

ACQUISITIONS

- 1998 ..... 900MHz cordless technology from AMD
- 1999 ..... VoicePump Inc. - VoIP Technology
- 2003 ..... Teleman Multimedia - Video Technology
- 2004 ..... Bermai Inc. leaders in advanced Wi-Fi technology
- 2007 ..... NXP's cordless and VoIP business
- 2011 ..... Bone-Tone